



EV Group and Dymek Company Form Joint Venture Company in Malaysia to Enhance Regional Customer Support – May 25, 2023

EV Group and Dymek Company Form Joint Venture Company in Malaysia to Enhance Regional

Customer Support

[Press Releases](#)

May 25, 2023 · By EV Group

[EV Group \(EVG\)](#), a leading supplier of wafer bonding and lithography equipment for the MEMS, nanotechnology and semiconductor markets, and [Dymek Company](#), an advanced equipment distributor for the semiconductor, biomedical, data storage, photovoltaic and aerospace industries, today announced that they have established a new joint venture company in Malaysia.

The new company, called EV Group Malaysia Dymek Sdn. Bhd., will be charged with managing EVG's customer support operations in Malaysia. Hermann Waltl, executive sales and customer support director and member of the executive board at EVG, will serve as director of the new joint venture, and Sean Lim from Dymek will serve as managing director of the new joint venture.

EV Group Malaysia Dymek is located at 70-3-31, D'Piazza Mall, Jalan Mahsuri, 11900 Bayan Lepas, Penang, Malaysia.

Working closely with EVG's headquarters, EV Group Malaysia Dymek will be responsible for numerous key regional customer support activities, including equipment installation, technical service and support, spare parts management and supply, and process development support. The company will be fully operational in July 2023.

"Malaysia has been an important center for semiconductor and microelectronics packaging, test, and assembly for several decades. As global investments from leading chip manufacturers and outsourced semiconductor assembly and test companies in the region continue to ramp up, it is vital that EVG strengthen its customer support infrastructure here as well," stated Hermann Waltl. "Dymek has been a key strategic partner for EVG in several countries in Asia already for many years, and we look forward to partnering with them to enhance our customer support in Malaysia as well."

"This strategic move by EV Group to establish a more direct presence in Malaysia will be well-received by the semiconductor and microelectronics industries of Southeast Asia. Companies here already recognize EVG as a market and technology leader in semiconductor process equipment, and now knowing they can receive local support from local engineers will only further increase their confidence and trust in EVG," stated Stanley Lam, managing director, Asia Pacific, at Dymek Company. "We are pleased to be working closely with EVG to grow and enhance their customer support infrastructure in Malaysia and across Southeast Asia."

See EVG at SEMICON Southeast Asia

EVG is a sponsor and program speaker at SEMICON Southeast Asia, taking place May 23-25 at the Setia SPICE Convention Centre in Penang, Malaysia. Attendees interested in learning more about EVG's latest developments in heterogeneous integration are welcome to attend the Advanced Packaging Forum on Wednesday, May 24 at 15:00 to see Dr. Thorsten Matthias, regional sales director Asia-Pacific for EVG, present on state of the art and upcoming requirements in wafer-to-wafer and die-to-wafer hybrid bonding.

<https://www.3dincites.com/2023/05/ev-group-and-dymek-company-form-joint-venture-company-in-malaysia-to-enhance-regional-customer-support/>